Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
151	20	257/704.ccls. and (@ad<"20030702") and (standoff or pillar)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23:22:50
L2	66	257/704.ccls. and (@ad<"20030702") and (standoff or pillar or spacer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 22:43
13	2	257/704.ccls. and (@ad<"20030702") and ((compress\$3 or resilient or elastomer or elastomeric or rubber or compliant) with (standoff or pillar or spacer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 22:45
L4	9370	(chip or die or "ic" or (integrated near circuit) or device) and (@ad<"20030702") and ((compress\$3 or resilient or elastomer or elastomeric or rubber or compliant) with (standoff or pillar or spacer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 22:46
L5	4563	L4 and (cap or lid or housing or sink or sprader)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 22:47
L6	4612	L4 and (cap or lid or housing or sink or spreader)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 22:47
L7	2319	L6 and (press or compress or compressive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 23:06
L8	593	L7 and (substrate or board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 22:49

L9	593	L7 and (substrate or board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 23:03
L10	2319	L6 and (press or compress or compressive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 22:51
L11	1	("5394010").PN.	USPAT	OR	OFF	2005/07/23 23:04
L12	1	("5723900").PN.	USPAT	OR	OFF	2005/07/23 23:04
L13	1	("6424031").PN.	USPAT	OR	OFF	2005/07/23 23:05
L14	1	("6218731").PN.	USPAT	OR	OFF	2005/07/23 23:05
L15	2319	L6 and (press or compress or compressive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/23 23:06